

ADF-STEM Imaging of Dopants and Defect Nanoclusters in Si

P. M. Voyles,* D. A. Muller,** and J. L. Grazul**

*Dept. of Materials Science and Engineering, University of Wisconsin – Madison, 1509 University Ave., Madison, WI, 53706-1595; voyles@engr.wisc.edu

**Bell Labs, Lucent Technologies, 700 Mountain Ave., Murray Hill, NJ 07974-0636

The ability to introduce free carriers into a silicon crystal by impurity doping has emerged as one of the potential roadblocks to the continued decrease in size of silicon microelectronic devices [1]. Future devices may require carrier (and thus dopant) concentrations $>10^{20} \text{ cm}^{-3}$ in a volume whose smallest dimension is $<50 \text{ nm}$ [2, 3]. Along with significant problems in device manufacturing, this produces (at least) two important challenges for microanalysis: (1) determining the impurity spatial distribution with sub-nm spatial resolution. (2) determining the structure of the defect responsible for the final limit on the free carrier concentration that can be achieved by doping.

Both of these challenges can be fruitfully addressed using annular dark-field (ADF) “Z-contrast” STEM imaging, provided we have a clear understanding of the physics of image formation. In the simplest picture, the ADF image intensity $I(\mathbf{r}) \propto P(\mathbf{r}) \otimes t(\mathbf{r})$, where $P(\mathbf{r})$ is the probe intensity and $t(\mathbf{r})$ is the specimen transmission function. This picture is inadequate for a zone-axis crystal because of very strong channeling of the incident probe causing it to change shape as a function of depth [4, 5]. A better picture is that the contribution to $I(\mathbf{r})$ from an atom at (\mathbf{r}_a, z_a) is proportional to the channeling-induced probe intensity at that atom $P(\mathbf{r}_a, z_a)$ weighted by $t(\mathbf{r}_a, z_a) \propto Z_a^{1.7}$ [6],

$$dI/dz(\mathbf{r}) = P(\mathbf{r}, z) \otimes t(\mathbf{r}, z), \text{ implying} \quad (1)$$

$$I(\mathbf{r}) = \int_0^t P(\mathbf{r}, z) \otimes t(\mathbf{r}, z) dz. \quad (2)$$

Fig. 1 shows plane-wave frozen-phonon multislice simulations indicating that dI/dz and $P(\mathbf{r}, z)$ calculated for a probe on a $\langle 110 \rangle$ Si column are proportional, as Eq. (1) predicts.

The excess intensity from substitutional dopant atom I_d/I_{Si} is therefore determined both by its Z and channeled probe it sees, so I_d/I_{Si} for a single impurity depends on the impurity depth in the sample. If the sample has low enough doping and small enough thickness, ($<7.7 \times 10^{21} \text{ cm}^{-3}$ at 50 \AA for $\langle 110 \rangle$ Si at 200 kV), this could be used to determine the depth and therefore the full three-dimensional position of the impurities. If we average over a number of columns on the order of the sample thickness (~ 10 - 100), the channeling contribution to Eq. (1) cancels out of I_d/I_{Si} , and it becomes

$$\frac{I_d}{I_{Si}} - 1 = n_d \frac{(Z_d^{1.7} - Z_{Si}^{1.7})}{Z_{Si}^{1.7}}, \quad (3)$$

where n_d is the number fraction of dopant atoms [6]. For $d = \text{Sb}$ and $I_d/I_{Si} = 1\%$, we can quantitatively measure dopant concentrations of $\sim 10^{19} \text{ cm}^{-3}$ by averaging over 25 atomic columns.

Channeling can also help address the second challenge, determining the structure of individual defect clusters. Defects involving two or more dopant atoms and either a Si vacancy [7, 8] or a Si bond reconstruction [9] have been proposed. We have recently demonstrated ADF-STEM images showing contrast from individual Sb atoms in Si [10]. These images showed that the defect can contain only two dopant atoms. One structural difference between various pair defects is the

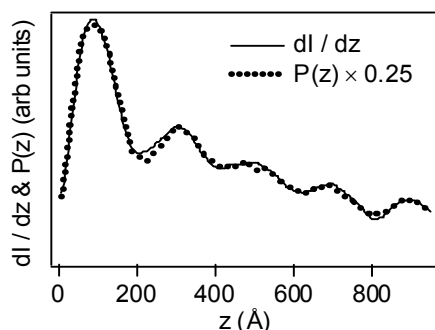


Fig. 1: dI/dz and $P(z)$ simulated for a 200 kV 1.0 mm C_s probe incident on an atomic column of $\langle 110 \rangle$ Si. They are proportional, indicating that Eq. (1) is valid.

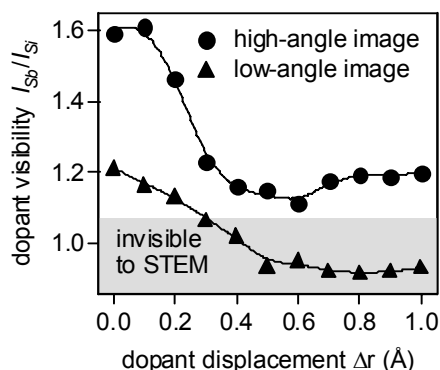


Fig. 2. Simulated I_d/I_{Si} for $d=Sb$ as a function of Δr .

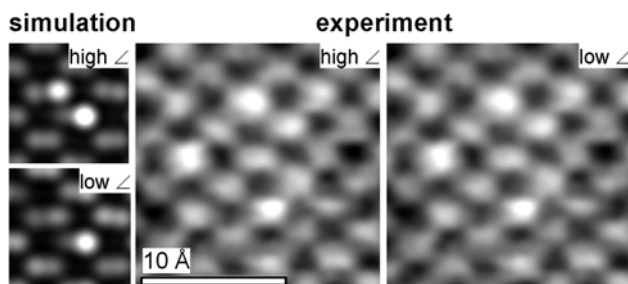


Fig 3: (left) Simulated images of a defect in which one dopants has a large $\Delta r = 0.7$ Å and is invisible in the low-angle image. (right) Experimental images of Sb-doped Si. The brightest columns contain one Sb atom, and are bright in both images, indicating Δr for these Sb atoms is $< \sim 0.3$ Å. Of several hundred Sb atoms in the full-field high-angle images, only a statistically insignificant fraction (similar to the false positive detection rate of $\sim 3\%$) were not found in the low-angle images.

distance Δr that the dopants are pulled off their substitutional positions. Channeling draws the probe tightly onto the atomic column, so the I_d/I_{Si} of dopants falls with increasing Δr , as shown in simulations in Fig. 2.

Conclusions based on absolute electron micrograph intensities are notoriously unreliable, so we use the Si lattice as an online standard. At lower detector angles, the Si lattice contrast grows stronger, reducing I_d/I_{Si} . Therefore, while essentially all of the dopants will appear in a high-angle image [10], dopants with large Δr will not appear in a low-angle image of the same area. A STEM can acquire both images simultaneously, so they are guaranteed to be in exact registration.

Using this technique, we have determined that the primary deactivating defect in Sb-doped Si has $\Delta r < 0.3$ Å, which is inconsistent with either of the dominant defects in the literature [11]. Sample images are shown in Fig. 3. We have therefore proposed a new defect, in which most of the structural dislocation is centered on a Si Frenkel pair, leaving the Sb atoms relatively undisturbed [11].

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